

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5845967

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HENG-KANG WU	10/10/2019
FU-JIN PENG	11/05/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FU DING PRECISION COMPONENT (SHEN ZHEN) CO., LTD.
<b>Street Address:</b>	Baoyuan Technology Area, By South Guanguang Road,,Longhua District, Shenzhen City, Guangdong Provinc
<b>City:</b>	Shenzhen
<b>State/Country:</b>	CHINA
<b>Name:</b>	FOXCONN INTERCONNECT TECHNOLOGY LIMITED
<b>Street Address:</b>	Cricket Square, Hutchins Drive, P.O. Box 2681,Grand Cayman KY1-1111, Cayman Islands
<b>City:</b>	Grand Cayman
<b>State/Country:</b>	CAYMAN ISLANDS
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16700975
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)919-8353
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	4089196137
<b>Email:</b>	joseph.chung@fit-foxconn.com,sou-proce7@foxconn.com,sou-proce7@fit-foxconn.com
<b>Correspondent Name:</b>	WEI TE CHUNG
<b>Address Line 1:</b>	408 E PLUMERIA DR.
<b>Address Line 4:</b>	SAN JOSE, CALIFORNIA 95134
<b>ATTORNEY DOCKET NUMBER:</b>	US75025
<b>NAME OF SUBMITTER:</b>	WEI TE CHUNG
<b>SIGNATURE:</b>	/WEI TE CHUNG/
<b>DATE SIGNED:</b>	12/02/2019
<b>Total Attachments: 3</b>	

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**ASSIGNMENT**

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. HENG-KANG WU , residing at Kunshan, China
- 2. FU-JIN PENG , residing at Kunshan, China
- 3. \_\_\_\_\_ , residing at \_\_\_\_\_
- 4. \_\_\_\_\_ , residing at \_\_\_\_\_
- 5. \_\_\_\_\_ , residing at \_\_\_\_\_
- 6. \_\_\_\_\_ , residing at \_\_\_\_\_
- 7. \_\_\_\_\_ , residing at \_\_\_\_\_

hereby sell(s), assign(s) and transfer(s) unto: (1) **FUDING PRECISION COMPONENTS (SHENZHEN) CO., LTD**, having a principal place of business at **Baoyuan Technology Area, By South Guanguang Road, Guanlan Dashuikeng Village, Longhua District, Shenzhen City, Guangdong Province, China**, and (2) **FOXCONN INTERCONNECT TECHNOLOGY LIMITED** having a principal place of business at **Cricket Square, Hutchins Drive, P.O. Box 2681, Grand Cayman KY1-1111, Cayman Islands**, hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **SECURING MECHANISM FOR USE WITH PROCESSOR MODULE** for which the undersigned

[ ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_

[ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.



1.	_____	_____
	HENG-KANG WU	Date
2.	FU-JIN PENG	11/05/2019
	FU-JIN PENG	Date
3.	_____	_____
		Date
4.	_____	_____
		Date
5.	_____	_____
		Date
6.	_____	_____
		Date
7.	_____	_____
		Date
8.	_____	_____
		Date
9.	_____	_____
		Date